



High-end Power Semiconductor Manufacturer

KK1600A 3800-4000V

Fast Switching Thyristor

- Low switching losses
- Low reverse recovery charge
- Distributed amplified gate for high di_T/dt



Mean on-state current	I_{TAV}	1600 A
Repetitive peak off-state voltage	V_{DRM}	3800 – 4000 V
Repetitive peak reverse voltage	V_{RRM}	
Turn-off time	t_q	125; 160 μs
V_{DRM}, V_{RRM}, V	3800	4000
Voltage code	38	40
$T_j, ^\circ C$	– 60 – 125	

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Mean on-state current	A	1600 2400	$T_c=85^{\circ}\text{C}$; Double side cooled; $T_c=55^{\circ}\text{C}$;180° half-sine wave; 50 Hz	
I_{TRMS}	RMS on-state current	A	2510	$T_c=85^{\circ}\text{C}$; Double side cooled; 180° half-sine wave; 50 Hz	
I_{TSM}	Surge on-state current	kA	32.0 37.0	$T_j=T_{j\max}$ $T_j=25^{\circ}\text{C}$	180° half-sine wave; 50 Hz ($t_p=10\text{ ms}$); single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=I_{FGM}$; $V_G=20\text{ V}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt=2\text{ A}/\mu\text{s}$
			34.0 39.0	$T_j=T_{j\max}$ $T_j=25^{\circ}\text{C}$	180° half-sine wave; 60 Hz ($t_p=8.3\text{ ms}$); single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=I_{FGM}$; $V_G=20\text{ V}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt=2\text{ A}/\mu\text{s}$
I^2t	Safety factor	$\text{A}^2\text{s}\cdot 10^3$	5120 6845	$T_j=T_{j\max}$ $T_j=25^{\circ}\text{C}$	180° half-sine wave; 50 Hz ($t_p=10\text{ ms}$); single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=I_{FGM}$; $V_G=20\text{ V}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt=2\text{ A}/\mu\text{s}$
			4795 6310	$T_j=T_{j\max}$ $T_j=25^{\circ}\text{C}$	180° half-sine wave; 60 Hz ($t_p=8.3\text{ ms}$); single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=I_{FGM}$; $V_G=20\text{ V}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt=2\text{ A}/\mu\text{s}$
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	3800–4000	$T_{j\min}<T_j<T_{j\max}$; 180° half-sine wave; 50 Hz; Gate open	
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	3900–4100	$T_{j\min}<T_j<T_{j\max}$; 180° half-sine wave; 50 Hz;single pulse; Gate open	
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.75\cdot V_{DRM}$ $0.75\cdot V_{RRM}$	$T_j=T_{j\max}$; Gate open	

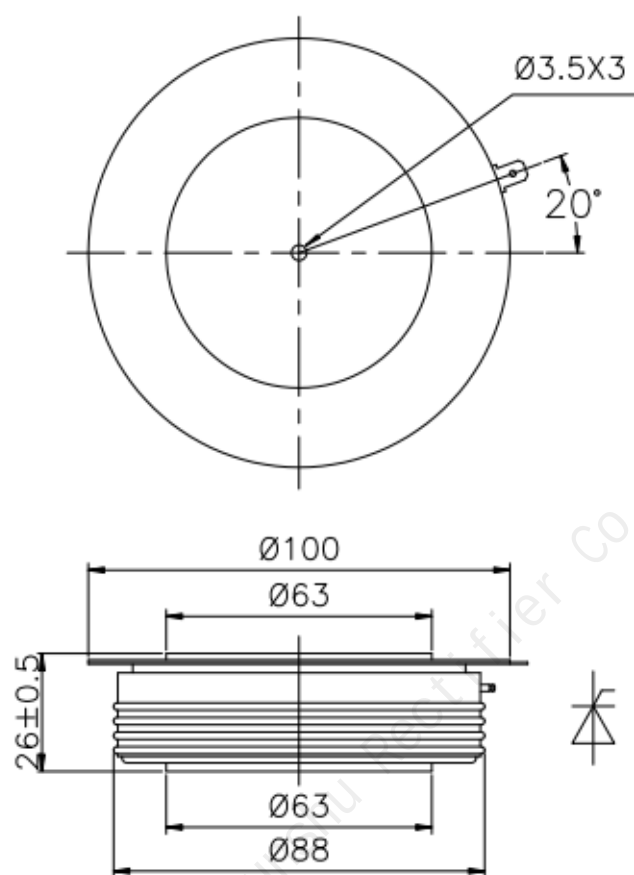
TRIGGERING				
I_{FGM}	Peak forward gate current	A	10	$T_j = T_{j\max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	8	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	2000	$T_j = T_{j\max}$; $V_D = 0.67 V_{DRM}$; $I_{TM} = 2 I_{TAV}$; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 50 \mu$ s; $di_G/dt = 2$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	$^{\circ}$ C	-60 – 125	
T_j	Operating junction temperature	$^{\circ}$ C	-60 – 125	
MECHANICAL				
F	Mounting force	kN	40.0 – 50.0	
a	Acceleration	m/s ²	50 100	Device unclamped Device clamped

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{TM}	Peak on-state voltage, max	V	2.70	$T_j=25\text{ }^{\circ}\text{C}$; $I_{TM}=5024\text{ A}$	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.44	$T_j=T_{j\text{ max}};$ $0.5\pi I_{TAV} < I_T < 1.5\pi I_{TAV}$	
r_T	On-state slope resistance, max	m Ω	0.270		
I_H	Holding current, max	mA	1000	$T_j=25\text{ }^{\circ}\text{C}$; $V_D=12\text{ V}$; Gate open	
BLOCKING					
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	300	$T_j=T_{j\text{ max}};$ $V_D=V_{DRM}; V_R=V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	1000	$T_j=T_{j\text{ max}};$ $V_D=0.67\cdot V_{DRM};$ Gate open	
TRIGGERING					
V_{GT}	Gate trigger direct voltage, max	V	5.00 3.00 2.00	$T_j= T_{j\text{ min}}$ $T_j=25\text{ }^{\circ}\text{C}$ $T_j= T_{j\text{ max}}$	$V_D=12\text{ V}$; $I_D=3\text{ A}$; Direct gate current
I_{GT}	Gate trigger direct current, max	mA	500 300 200	$T_j= T_{j\text{ min}}$ $T_j= 25\text{ }^{\circ}\text{C}$ $T_j= T_{j\text{ max}}$	
V_{GD}	Gate non-trigger direct voltage, min	V	0.35	$T_j=T_{j\text{ max}};$ $V_D=0.67\cdot V_{DRM};$	
I_{GD}	Gate non-trigger direct current, min	mA	15.00	Direct gate current	
SWITCHING					
t_{gd}	Delay time	μ s	3.5	$T_j=25\text{ }^{\circ}\text{C}$; $V_D=0.4\cdot V_{DRM}; I_{TM}=I_{TAV};$ Gate pulse: $I_G=I_{FGM}; V_G=20\text{ V};$ $t_{GP}=50\text{ }\mu\text{s}; di_G/dt=2\text{ A}/\mu\text{s}$	
t_q	Turn-off time ²⁾ , max	μ s	125; 160	$dv_D/dt=50\text{ V}/\mu\text{s};$	$T_j=T_{j\text{ max}};$ $I_{TM}= I_{TAV};$ $di_R/dt=-10\text{ A}/\mu\text{s};$ $V_R=100\text{V};$ $V_D=0.67 V_{DRM}$
			160; 200	$dv_D/dt=200\text{ V}/\mu\text{s};$	
Q_{rr}	Total recovered charge(linear), max	μ C	3000	$T_j=T_{j\text{ max}};$ $I_{TM}=2000\text{ A};$	
t_{rr}	Reverse recovery time, max	μ s	14	$di_R/dt=-50\text{ A}/\mu\text{s};$	
I_{rrM}	Peak reverse recovery current, max	A	430	$V_R=100\text{ V}$	

THERMAL					
R _{thjc}	Thermal resistance, junction to case, max	°C/W	0.0085	Direct current	Double side cooled
R _{thjc-A}			0.0187		Anode side cooled
R _{thjc-K}			0.0153		Cathode side cooled
R _{thck}	Thermal resistance, case to heatsink, max	°C/W	0.0020	Direct current	
MECHANICAL					
w	Weight, typ	g	1500		
D _s	Surface creepage distance	mm (inch)	36.6 (1.441)		
D _a	Air strike distance	mm (inch)	16.2 (0.638)		

OVERALL DIMENSIONS



KT70

All dimensions in millimeters

On-state characteristic model (see Fig. 1).

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j\max}$
A	1.799223	1.165741
B	0.106392	0.195115
C	-0.227901	-0.304378
D	0.350140	0.467637

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2).Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where $i = 1$ to n , n is the number of terms in the series.**t** = Duration of heating pulse in seconds. **Z_{thjc}** = Thermal resistance at time t . **R_i** = Amplitude of p_{th} term. **τ_i** = Time constant of r_{th} term.

DC Double side cooled

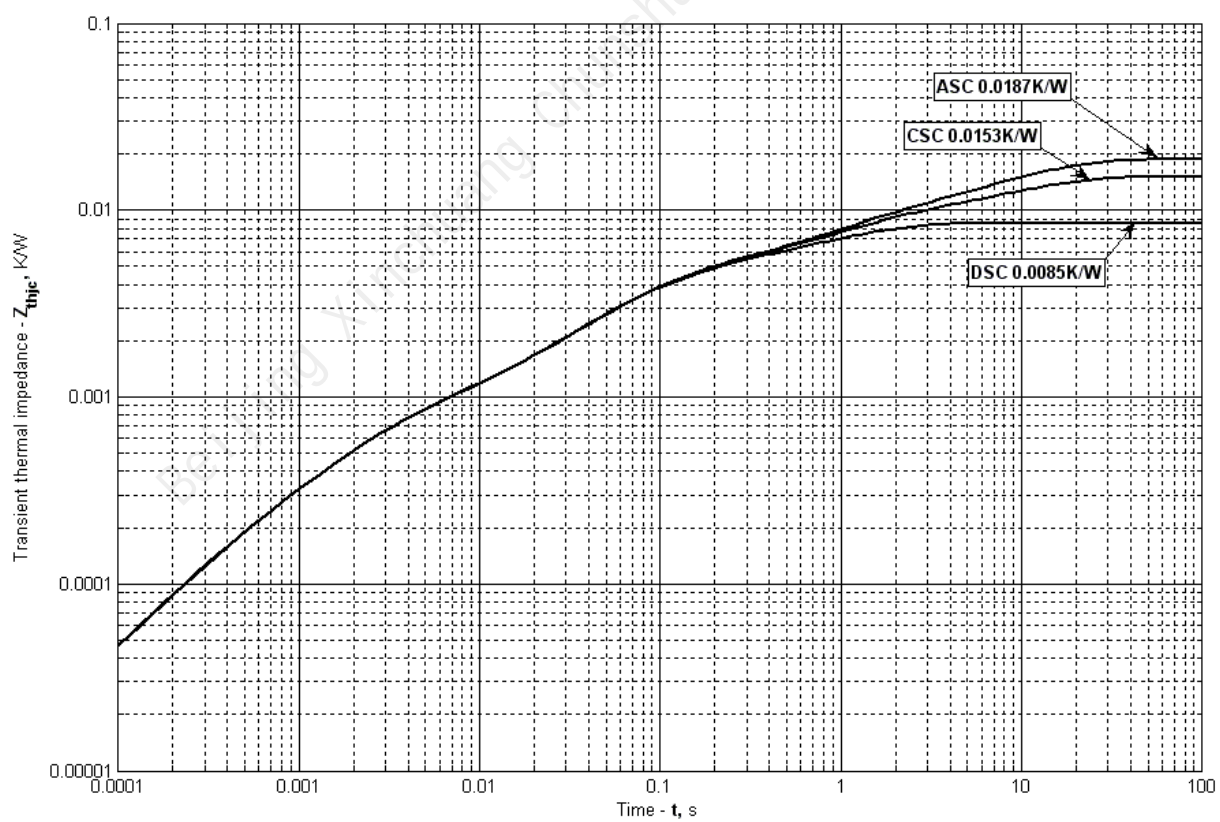
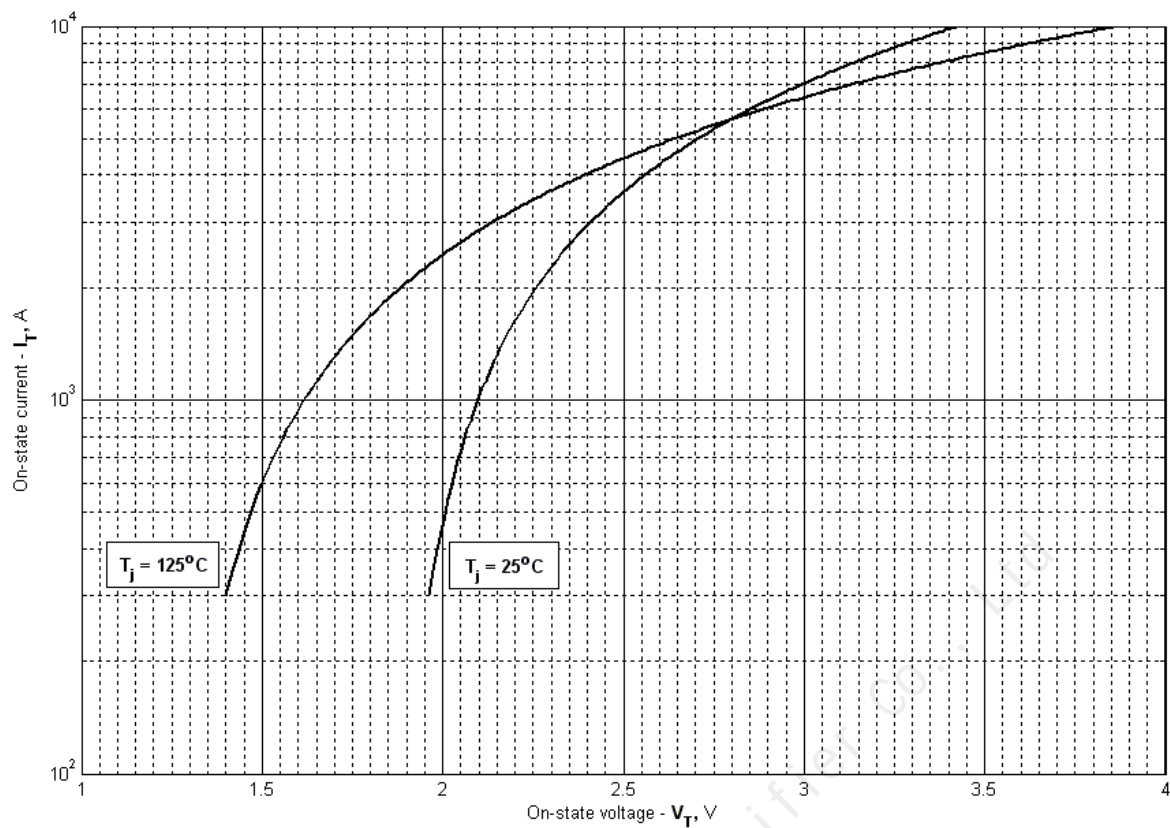
i	1	2	3	4	5	6
R_i, K/W	0.00007989	0.002973	0.0005936	0.000846	0.00005975	0.003948
τ_i, s	1.688	0.06219	0.002329	0.138	0.0003243	0.9533

DC Anode side cooled

i	1	2	3	4	5	6
R_i, K/W	0.01013	0.004062	0.0009401	0.002853	0.0005963	0.00005641
τ_i, s	9.747	1.058	0.1304	0.06179	0.002313	0.0003013

DC Cathode side cooled

i	1	2	3	4	5	6
R_i, K/W	0.006619	0.004034	0.0008595	0.002956	0.0005965	0.00005689
τ_i, s	9.744	1.025	0.1394	0.06237	0.002318	0.0003037



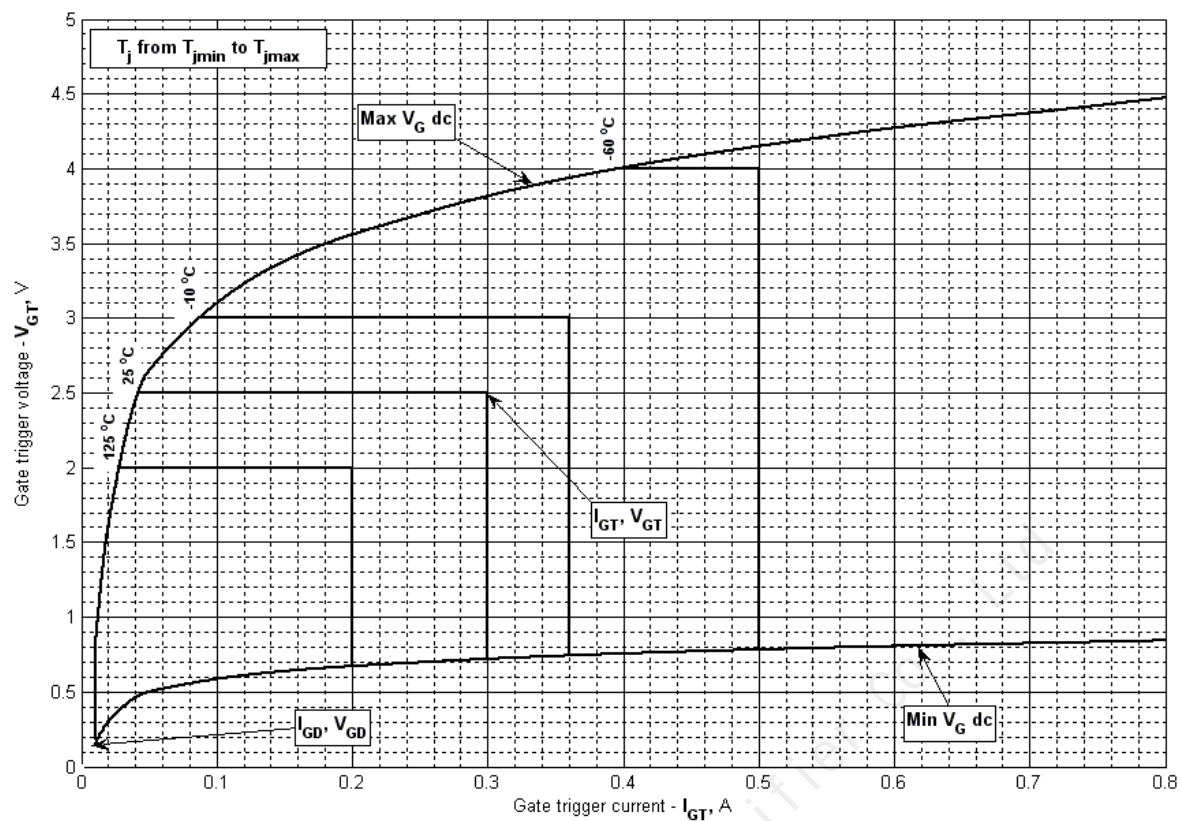


Fig 3 – Gate characteristics – Trigger limits

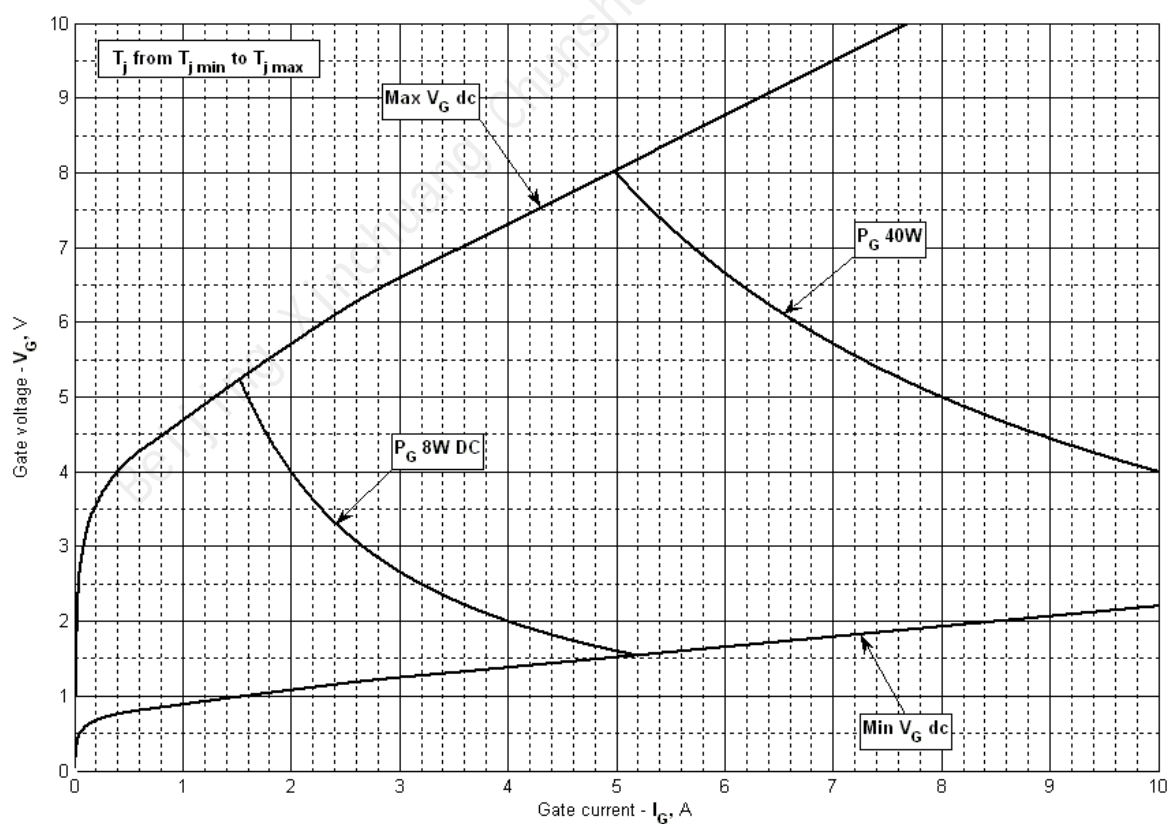


Fig 4 - Gate characteristics –Power curves

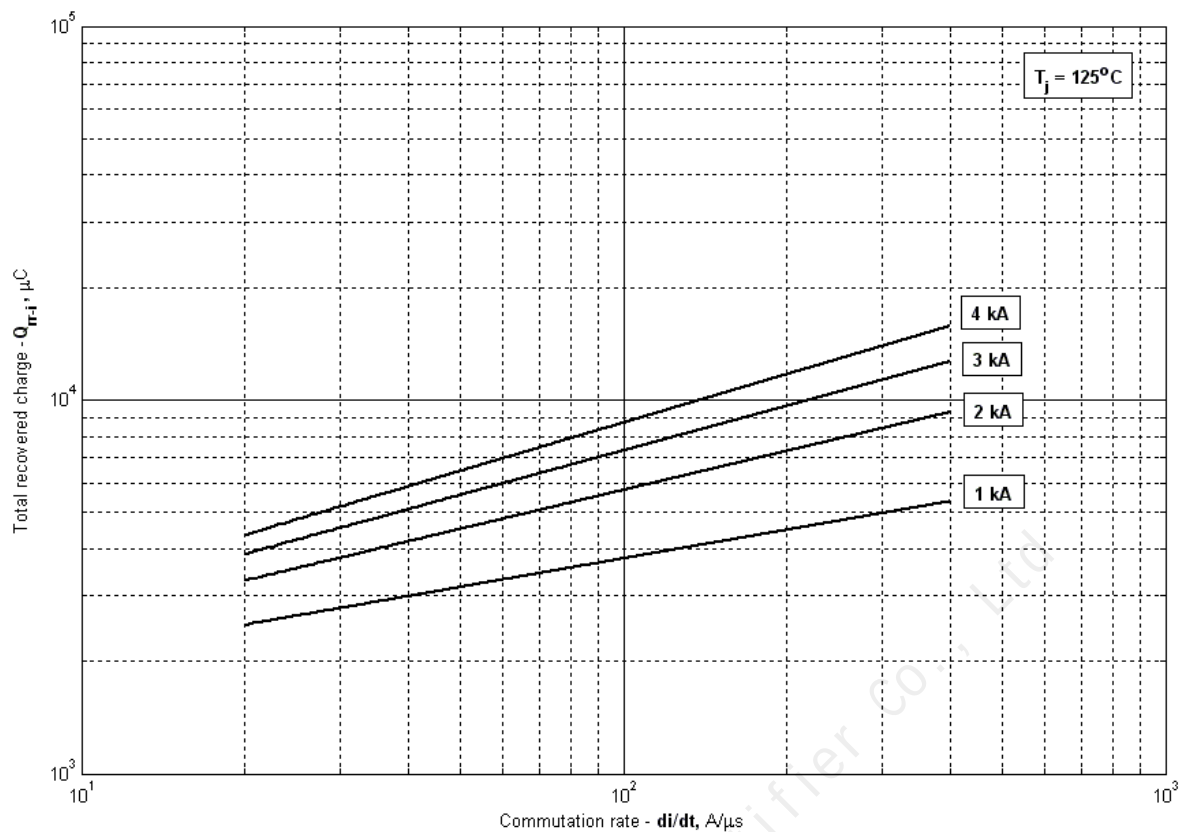


Fig 5 – Total recovered charge, Q_{rr-i} (integral)

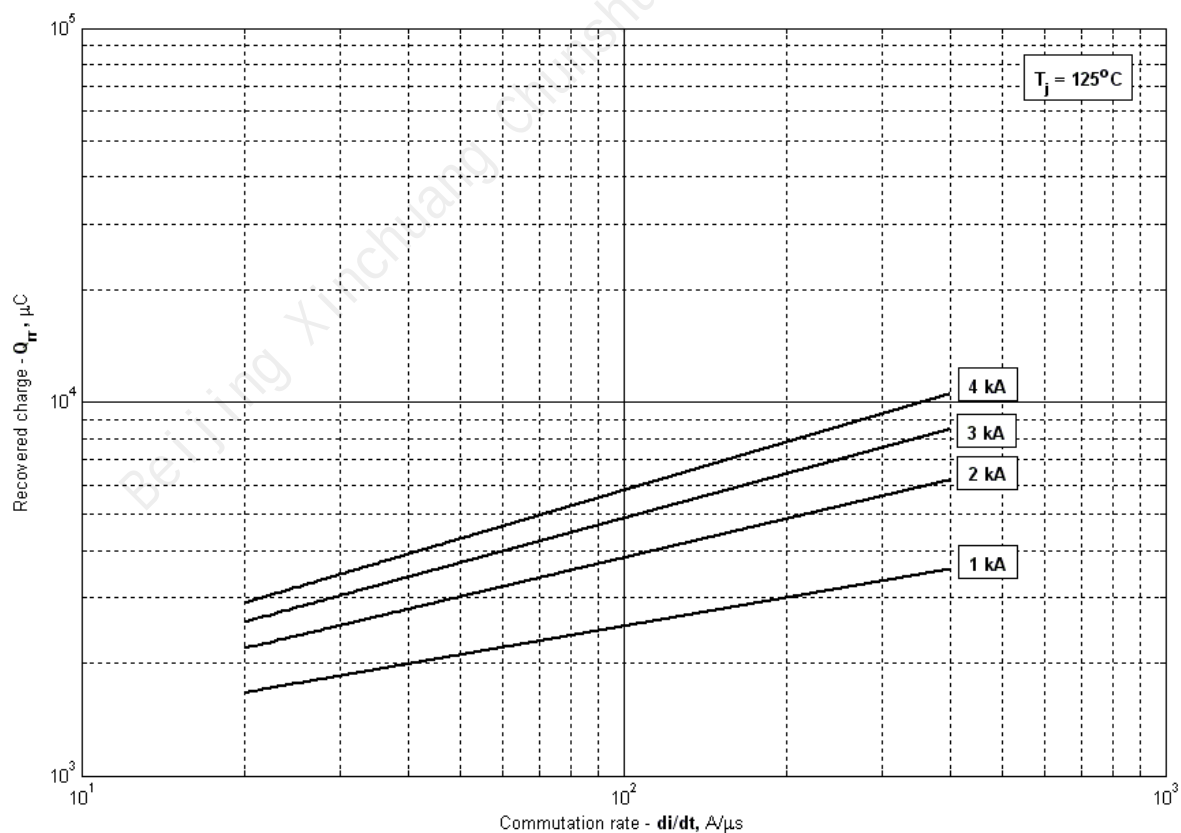


Fig 6 - Recovered charge, Q_{rr} (linear)

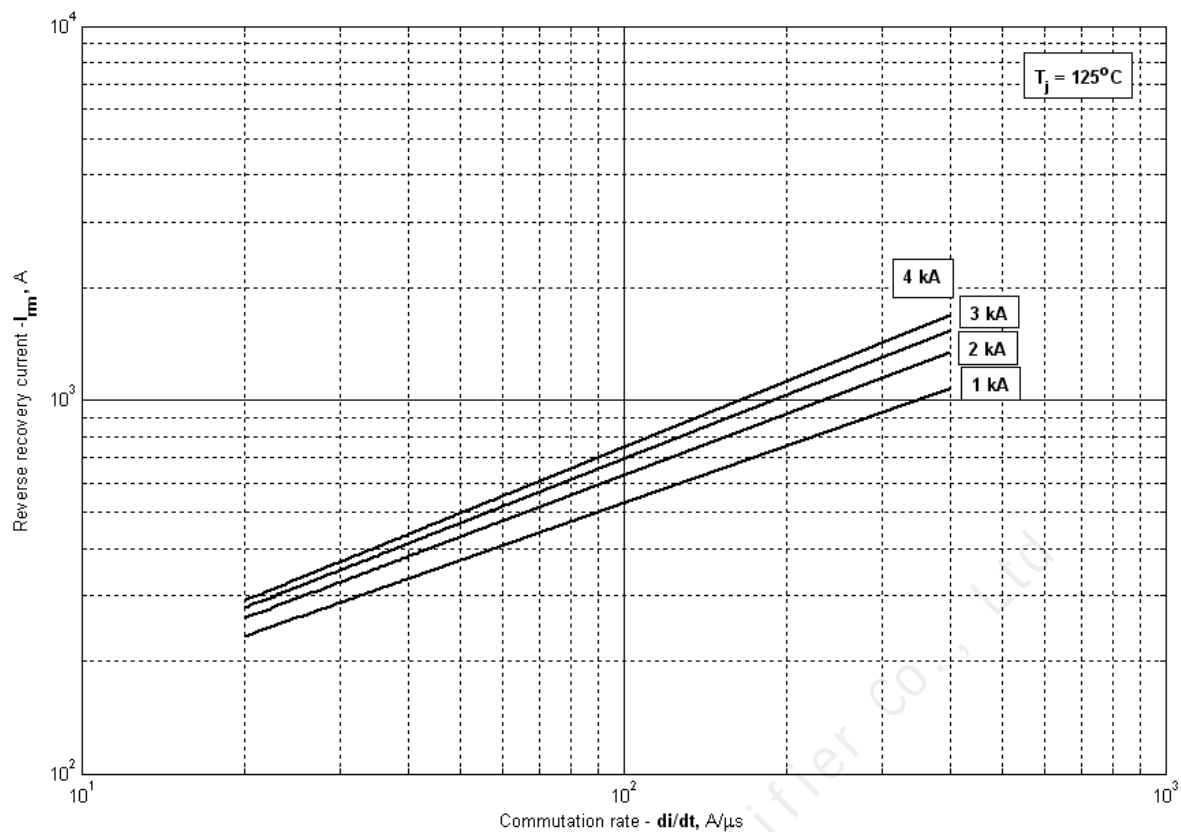


Fig 7 – Peak reverse recovery current, I_{rm}

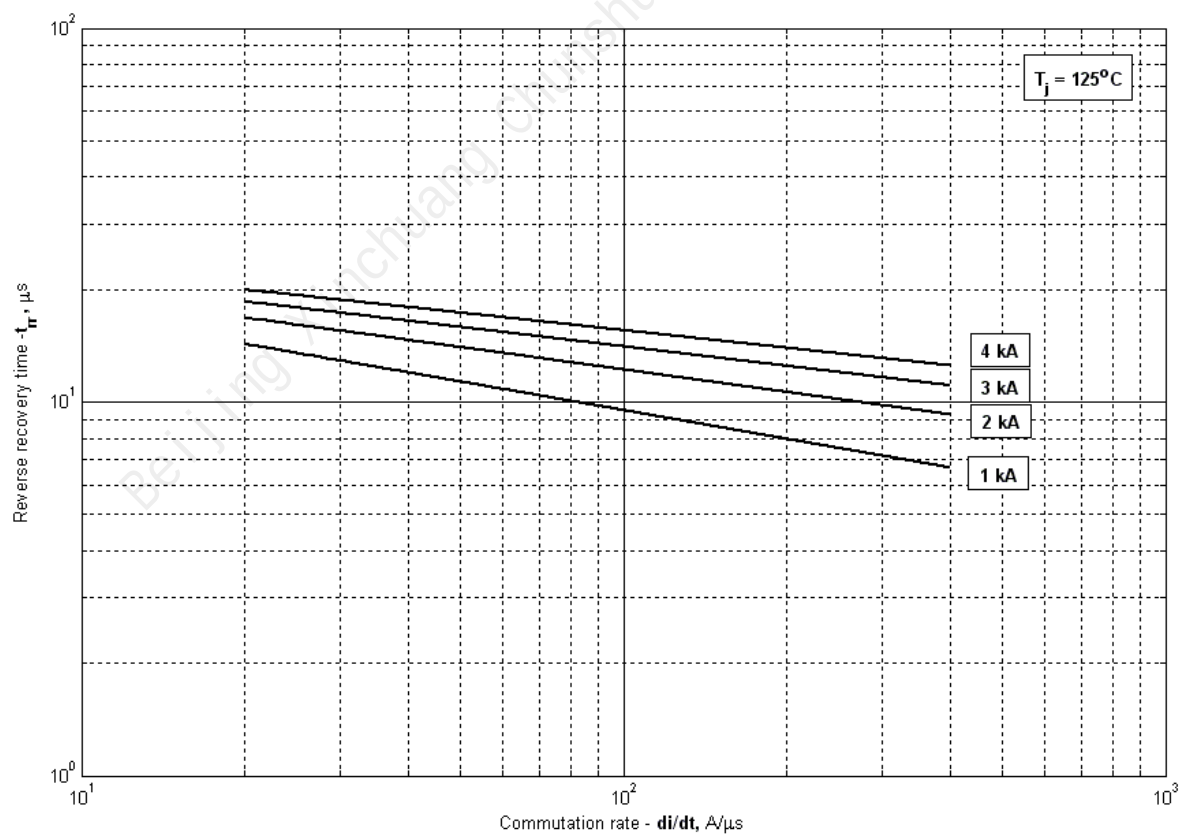


Fig 8 – Maximum recovery time, t_{rr} (linear)

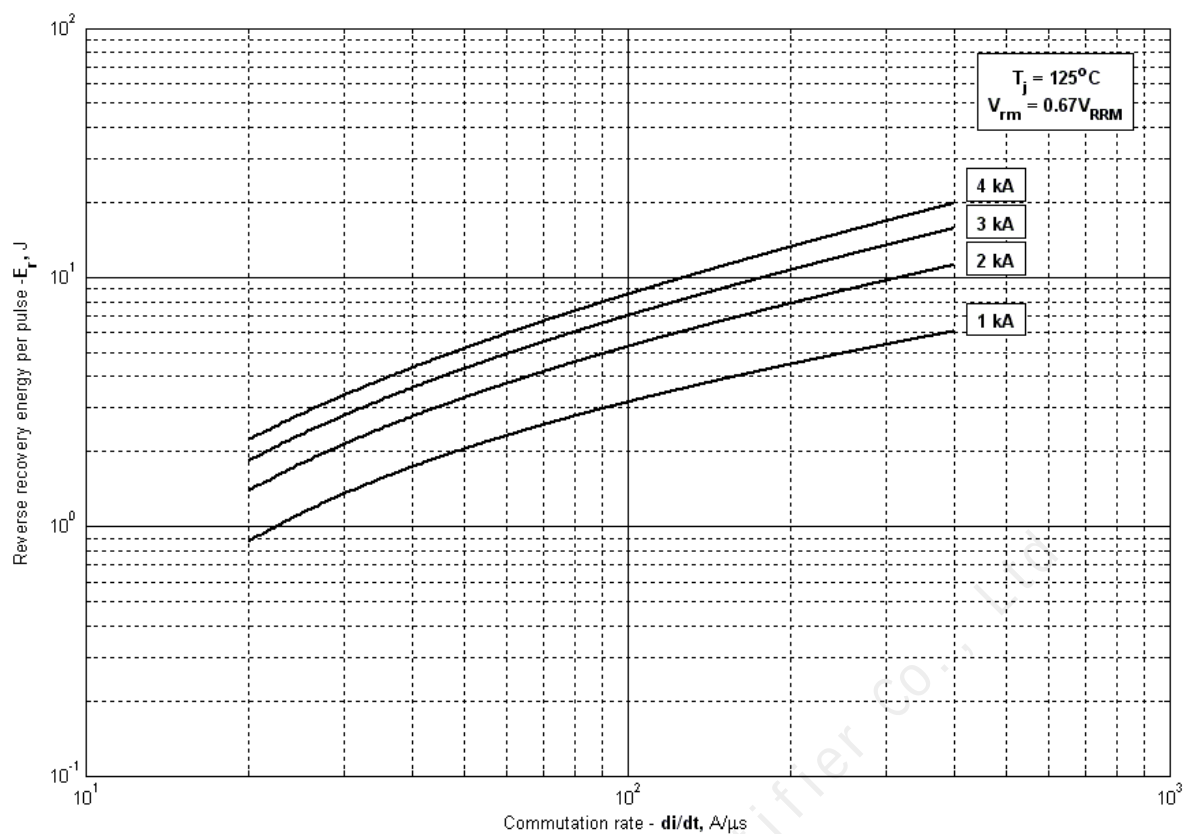


Fig 9 – Reverse recovery energy per pulse

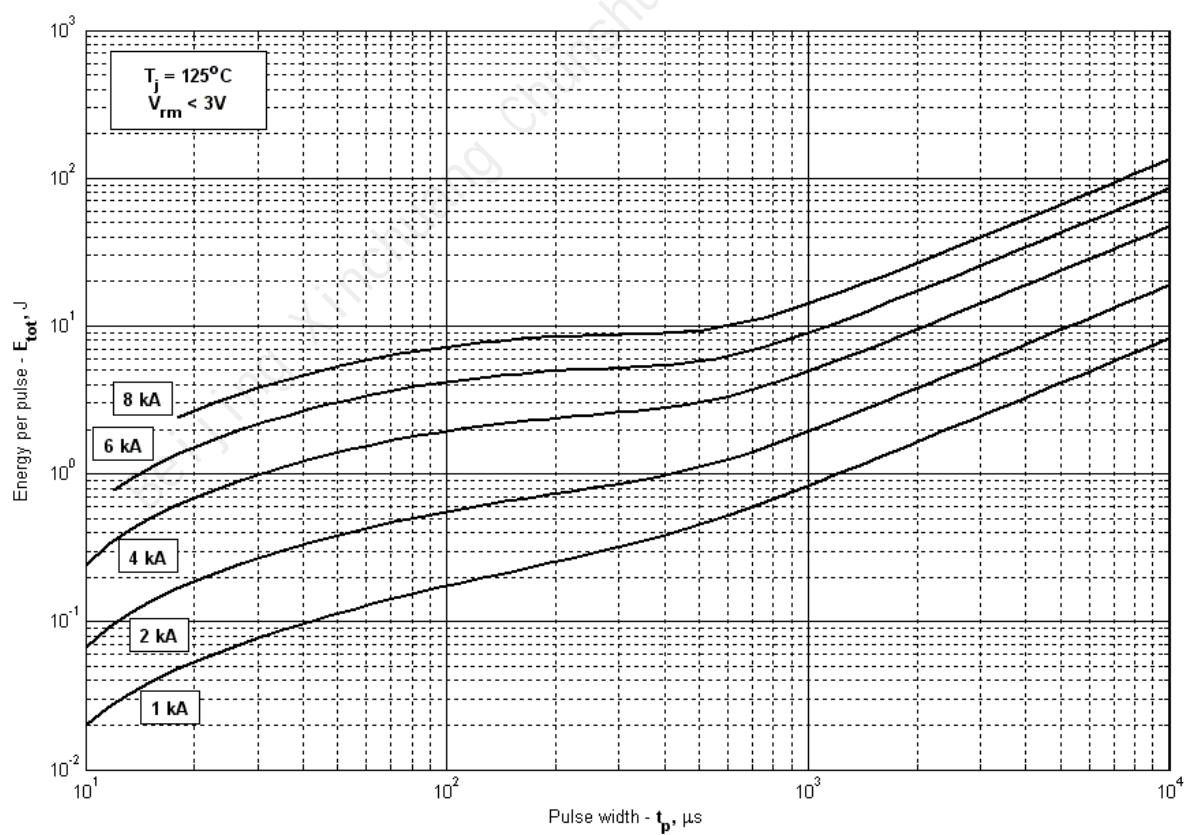


Fig 10 – Sine wave energy per pulse

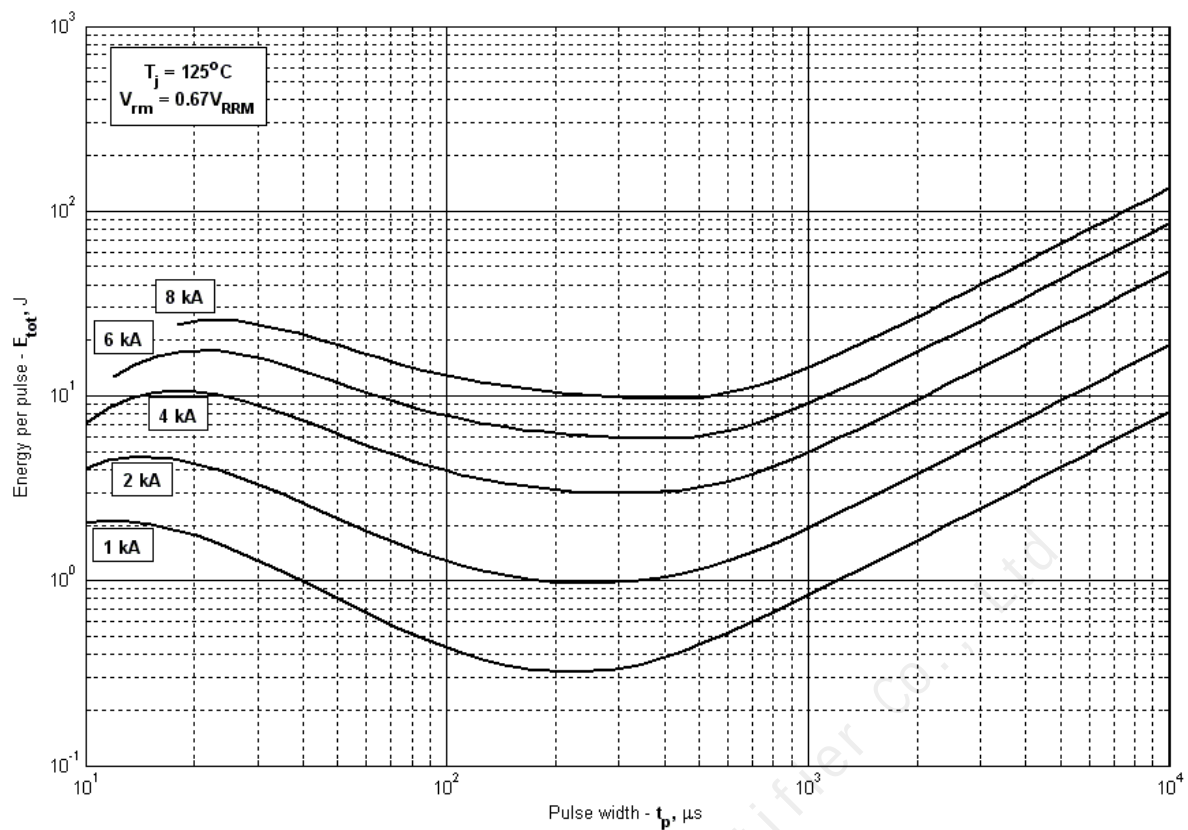


Fig 11 – Sine wave energy per pulse

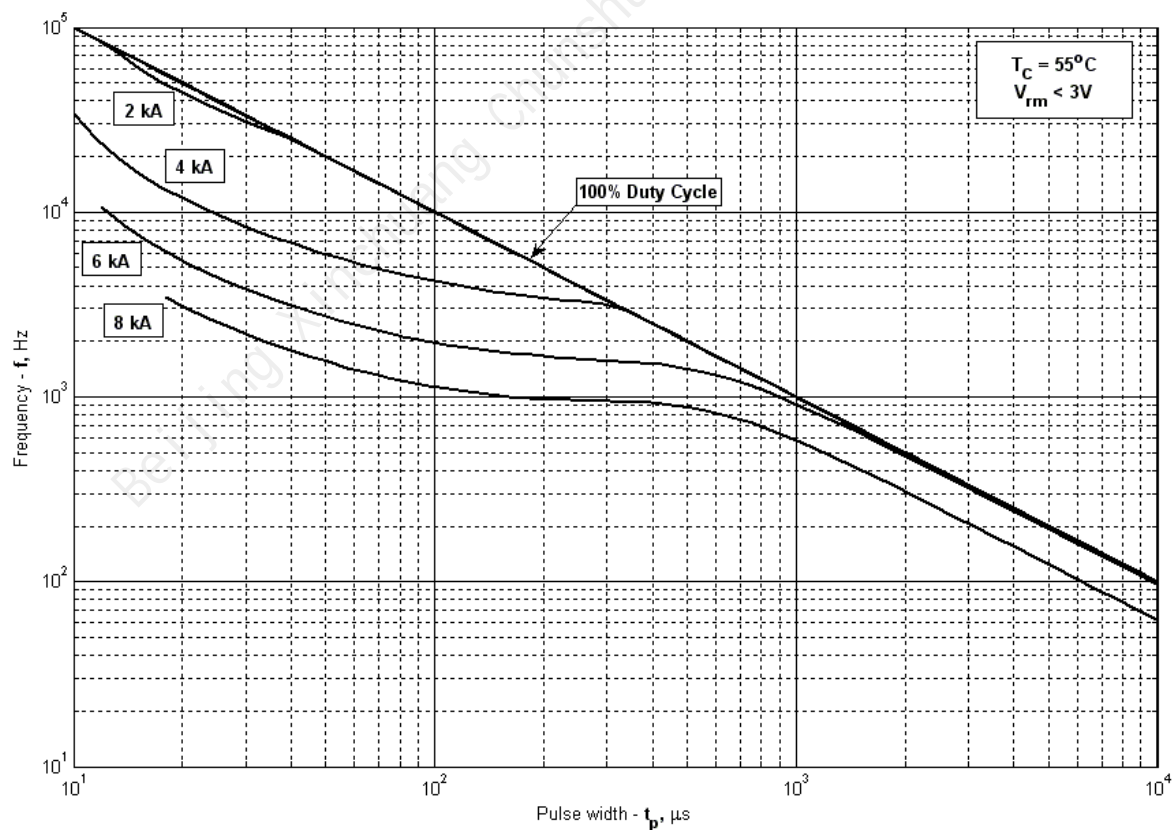


Fig 12 – Sine wave frequency ratings

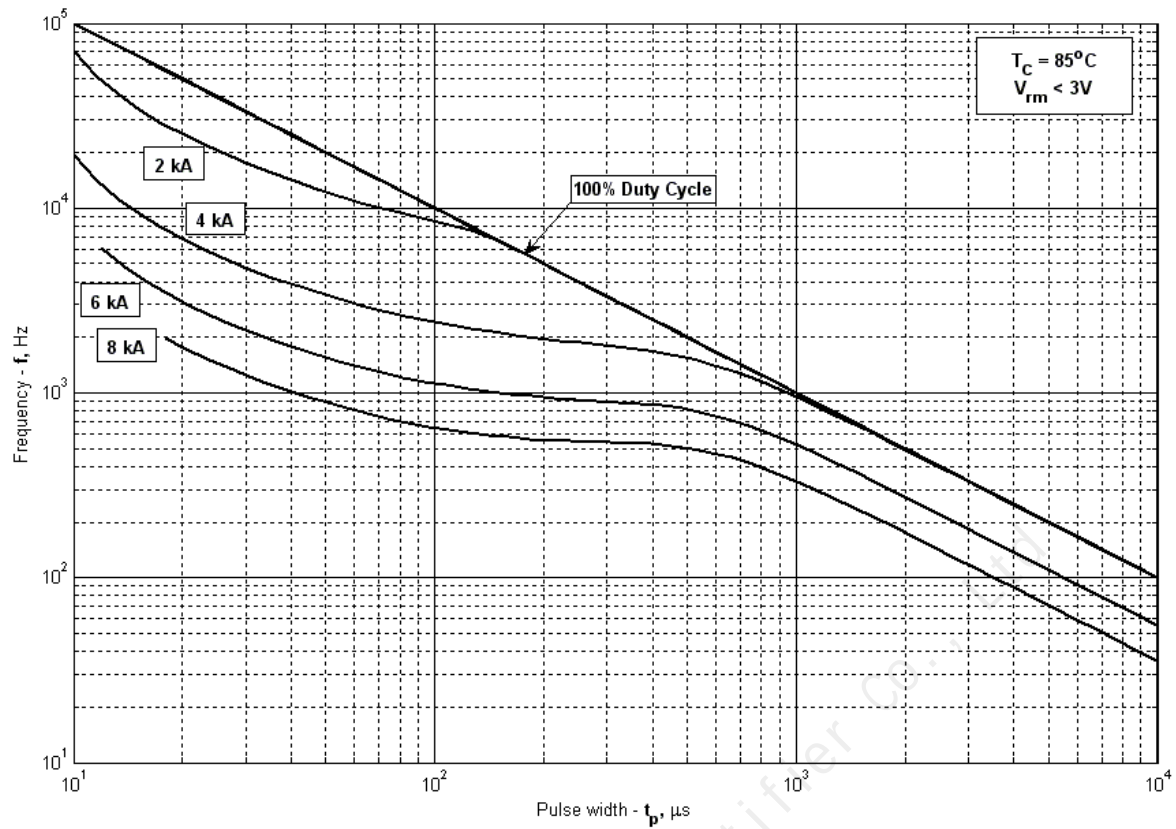


Fig 13 – Sine wave frequency ratings

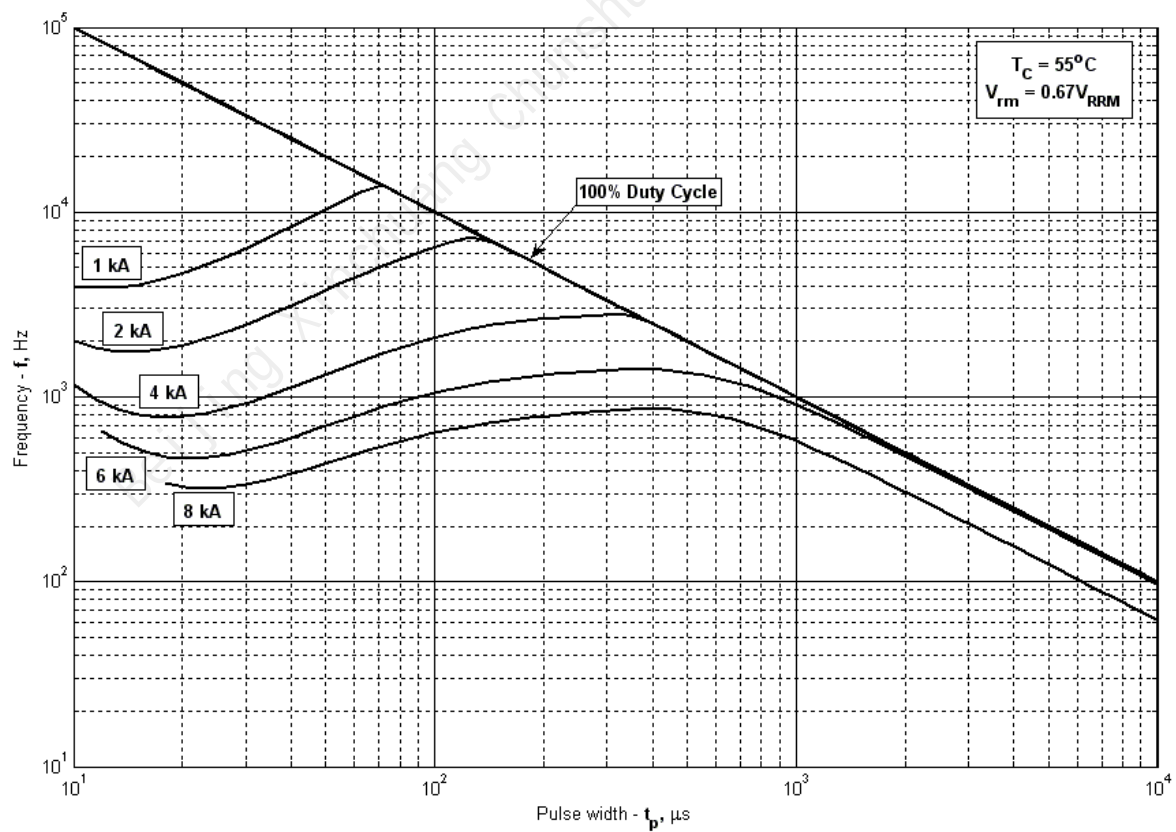


Fig 14 – Sine wave frequency ratings

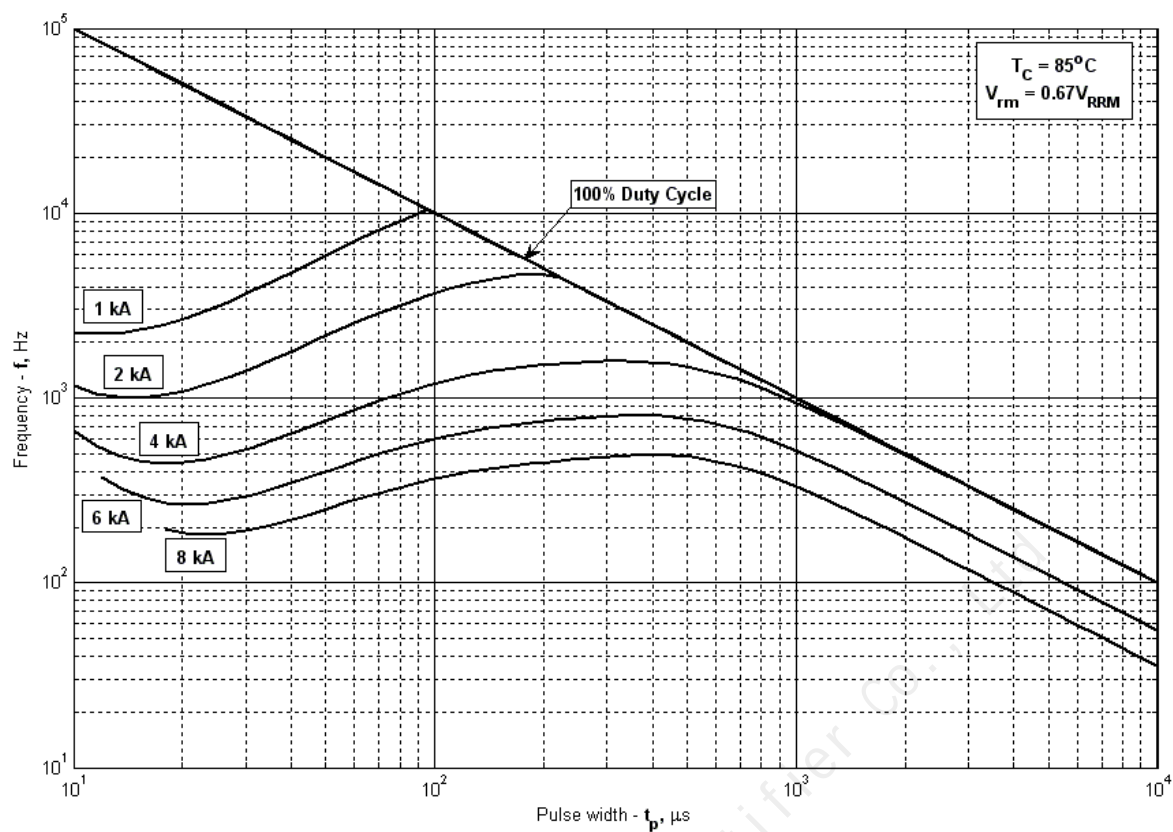


Fig 15 – Sine wave frequency ratings

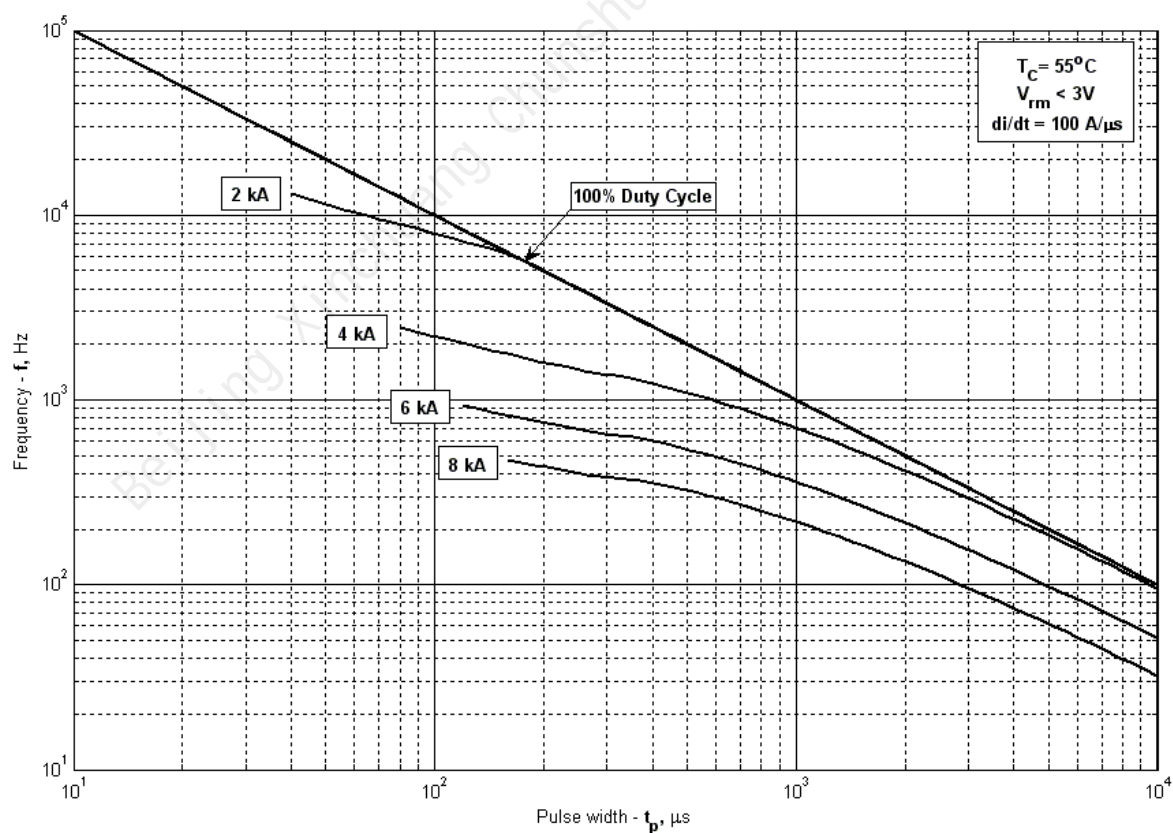


Fig 16 – Square wave frequency ratings

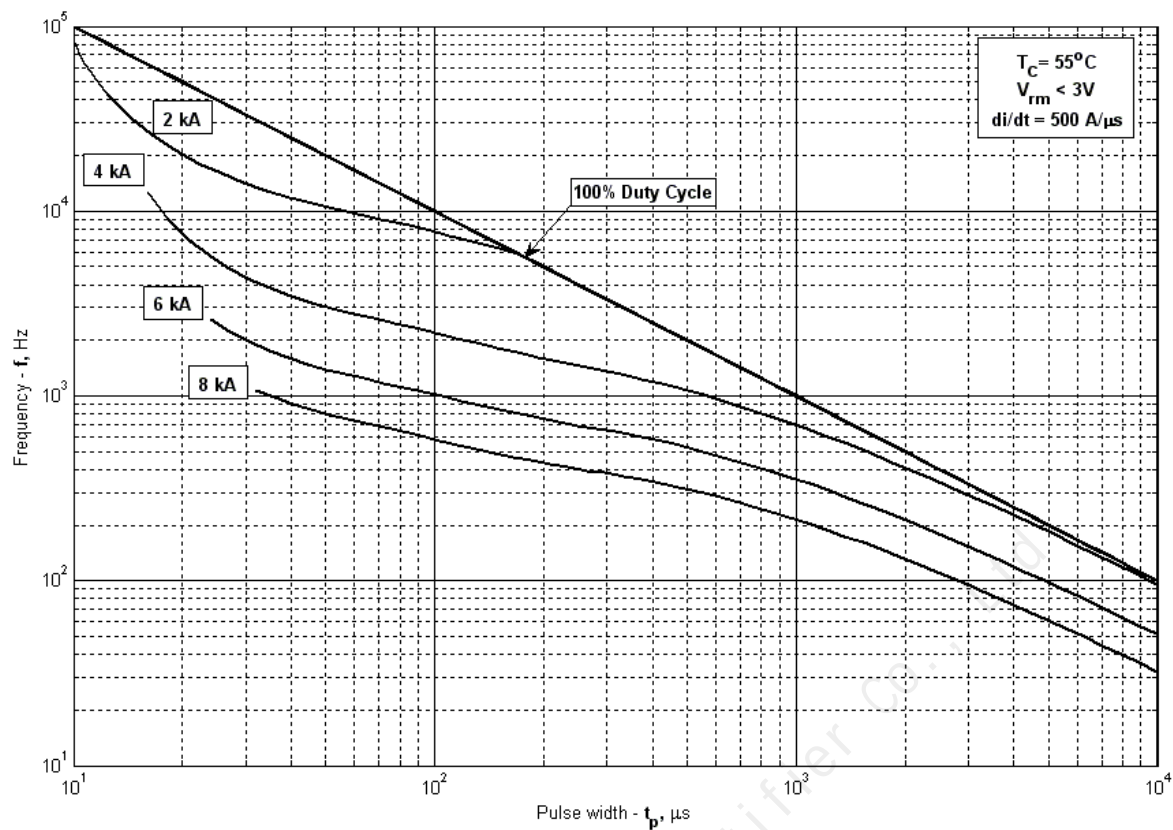


Fig 17 – Square wave frequency ratings

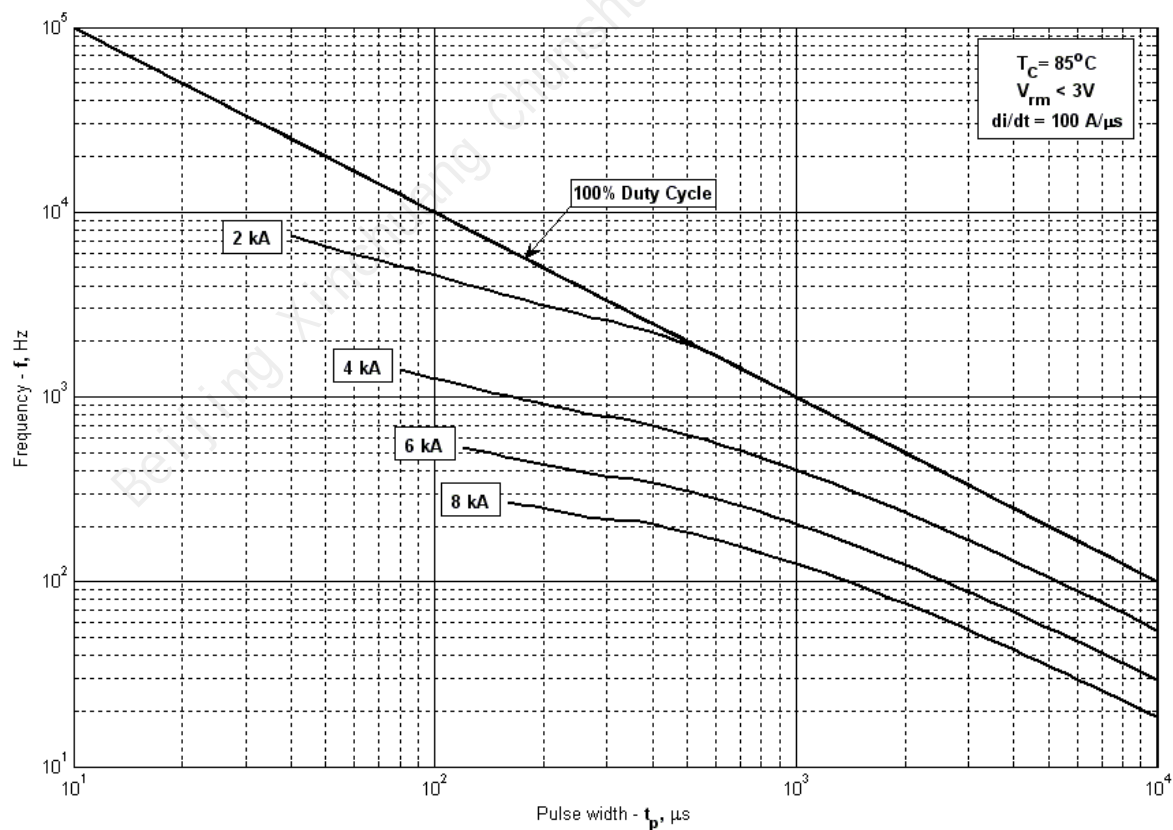


Fig 18 – Square wave frequency ratings

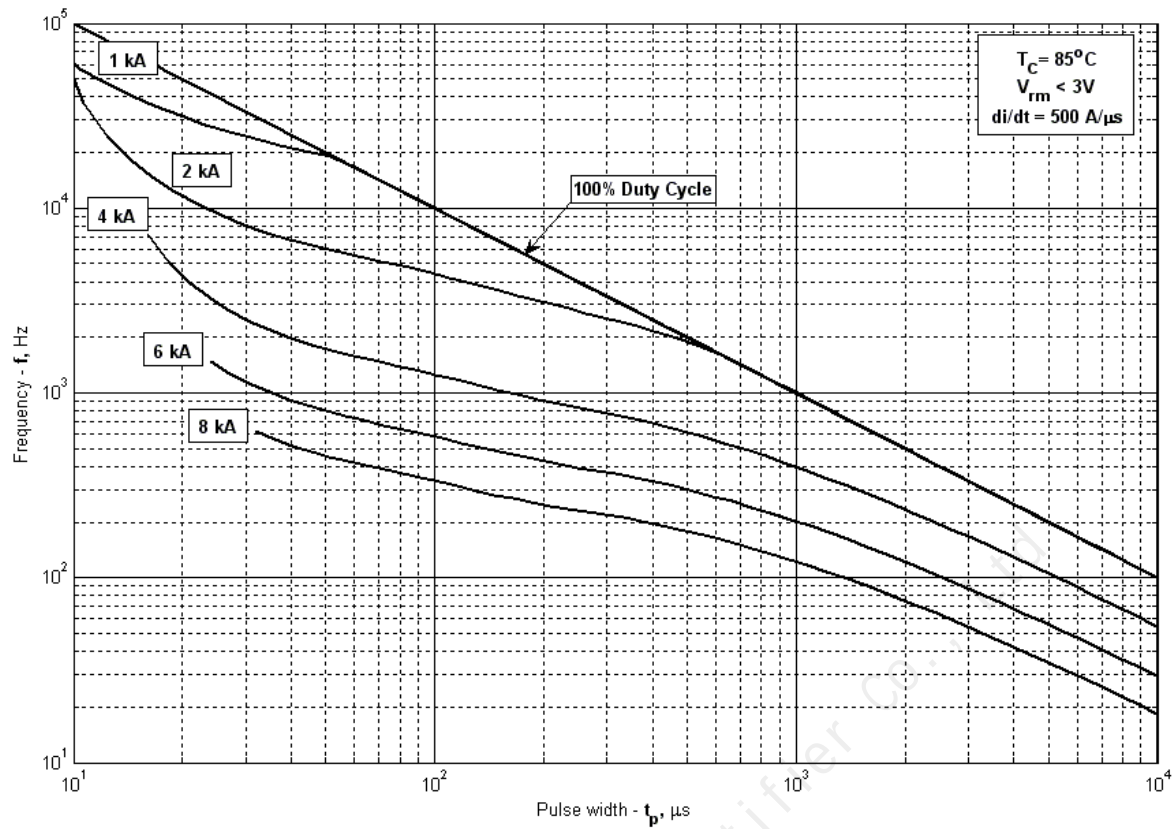


Fig 19 – Square wave frequency ratings

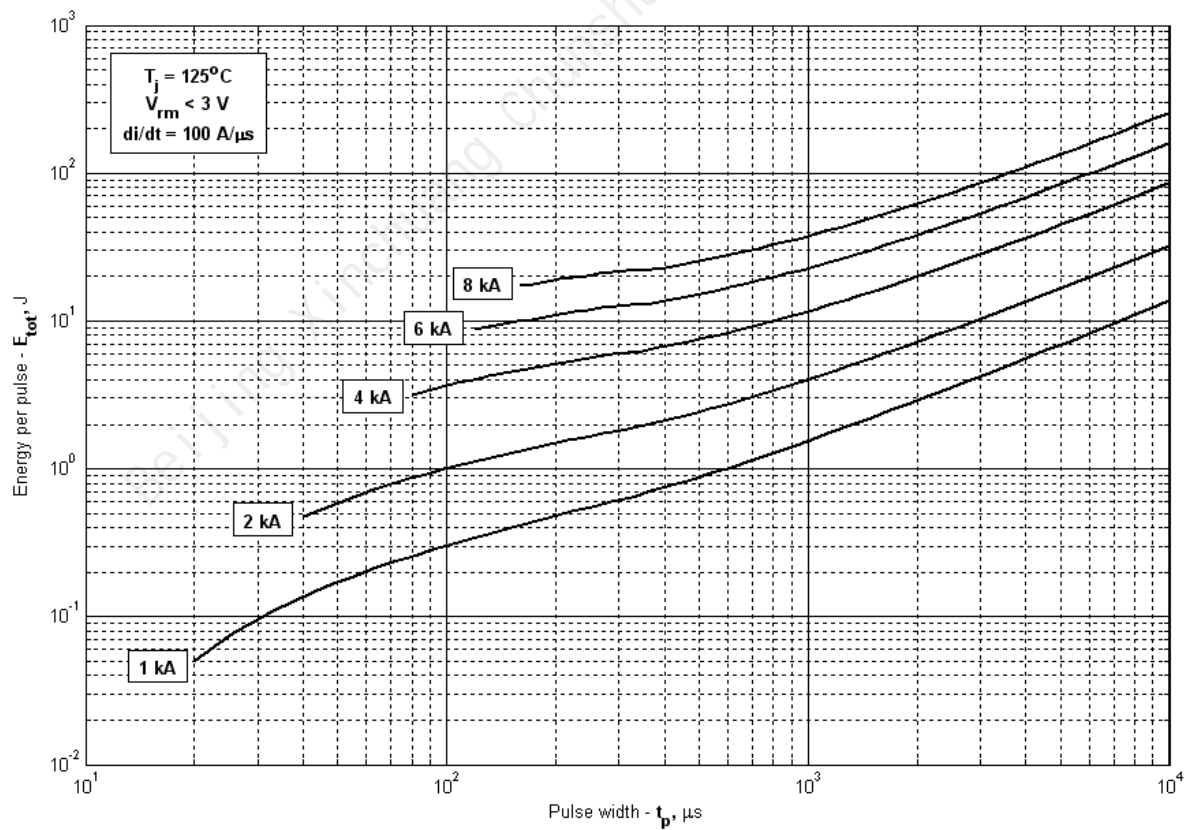


Fig 20 – Square wave energy per pulse

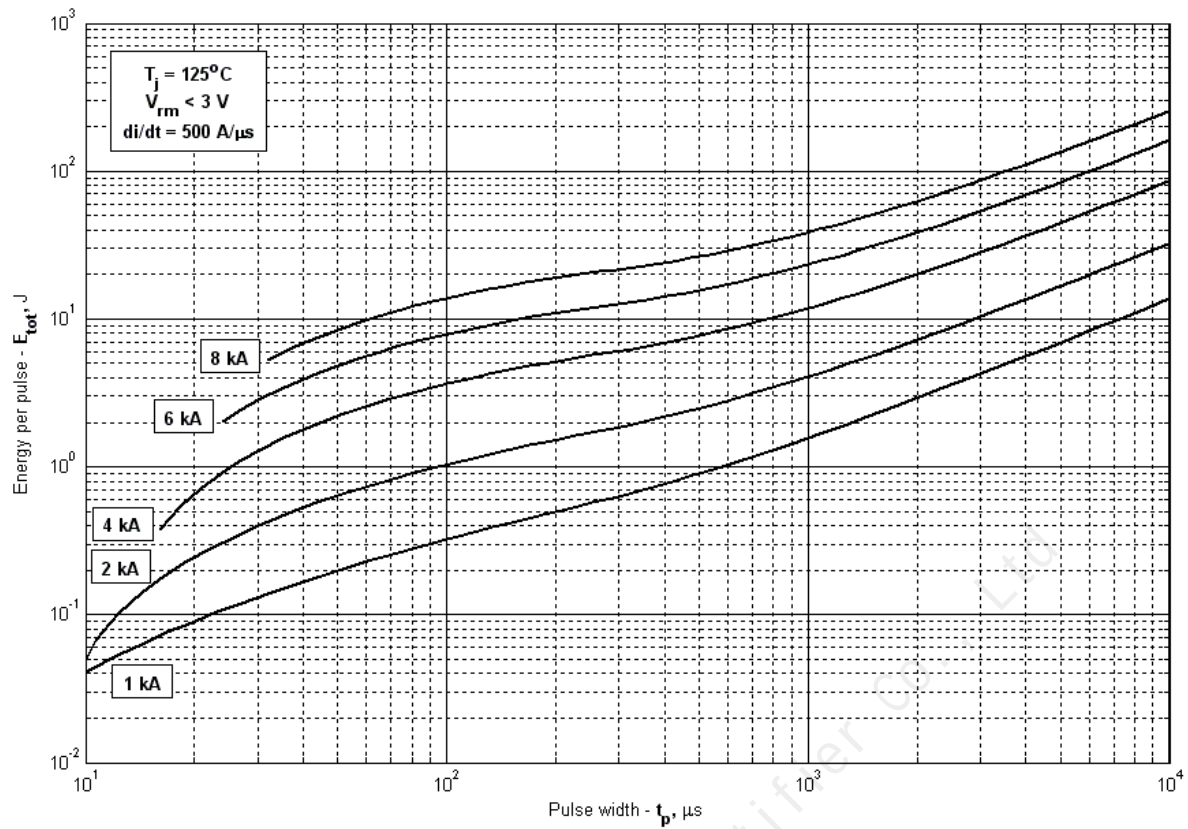


Fig 21 – Square wave energy per pulse

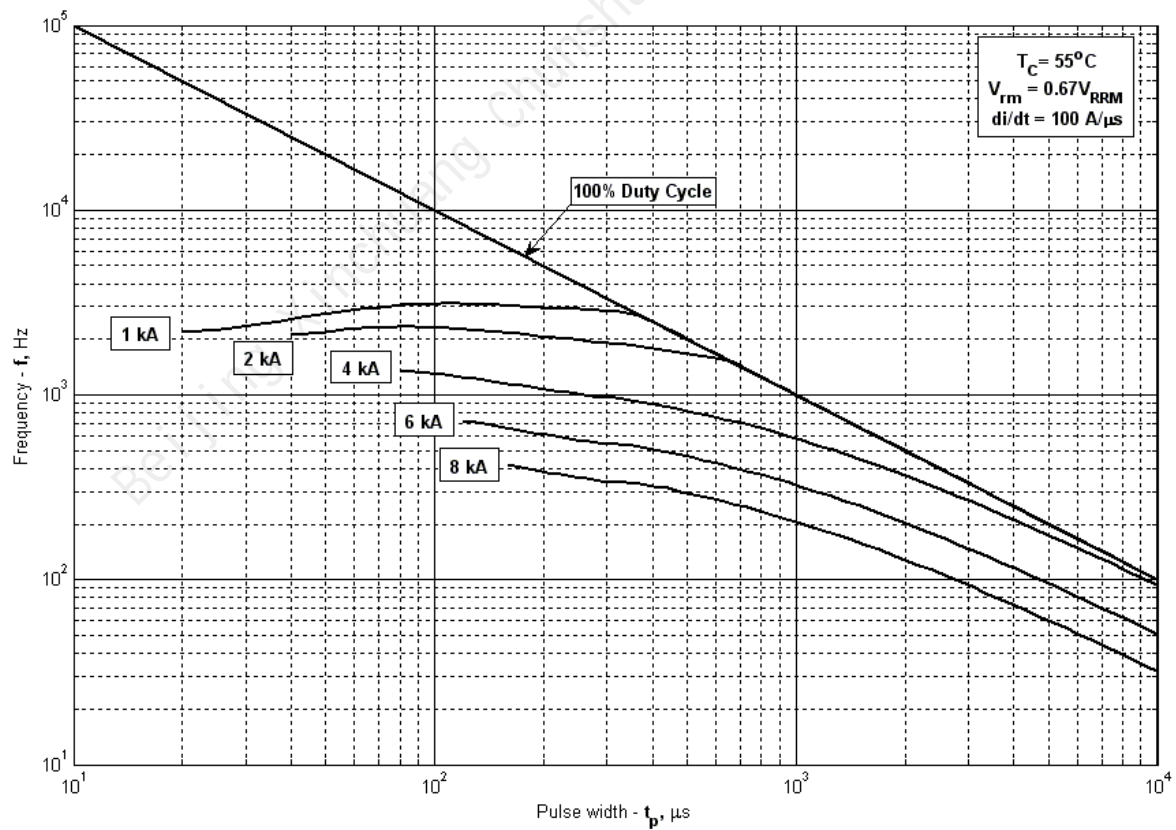


Fig 22 – Square wave frequency ratings

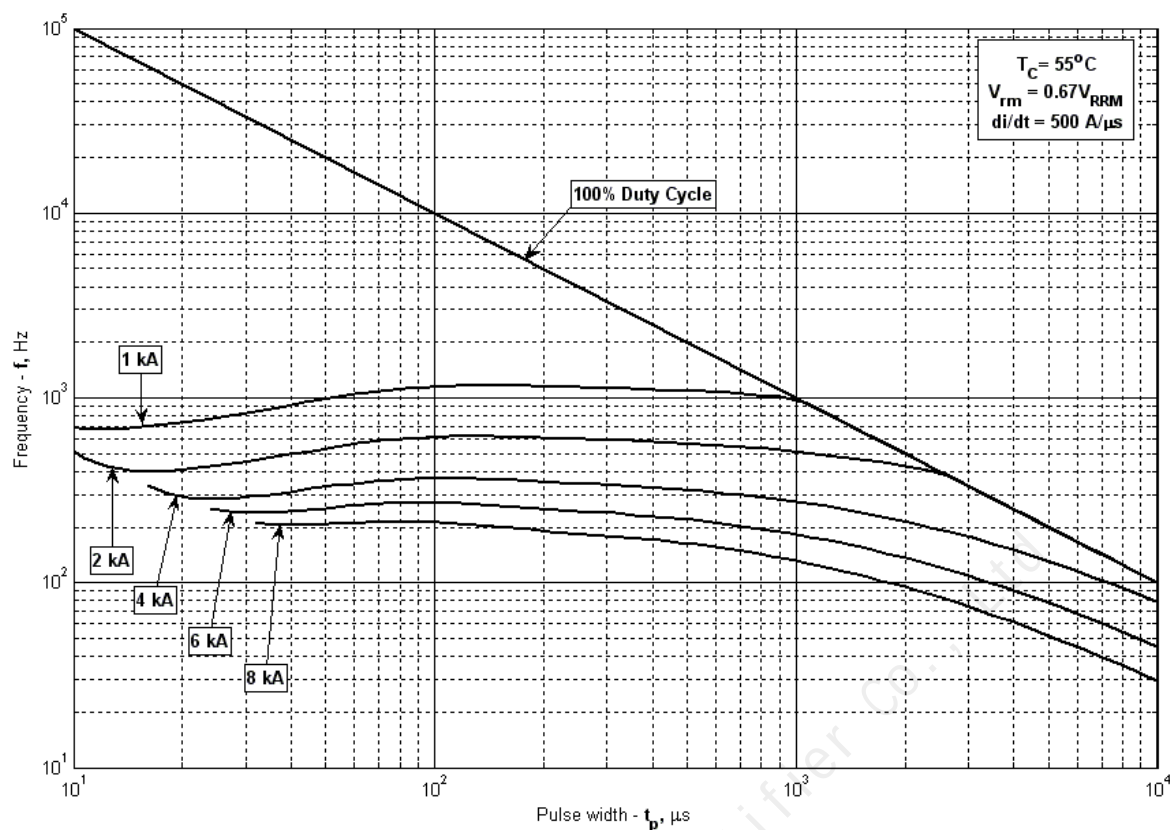


Fig 23 – Square wave frequency ratings

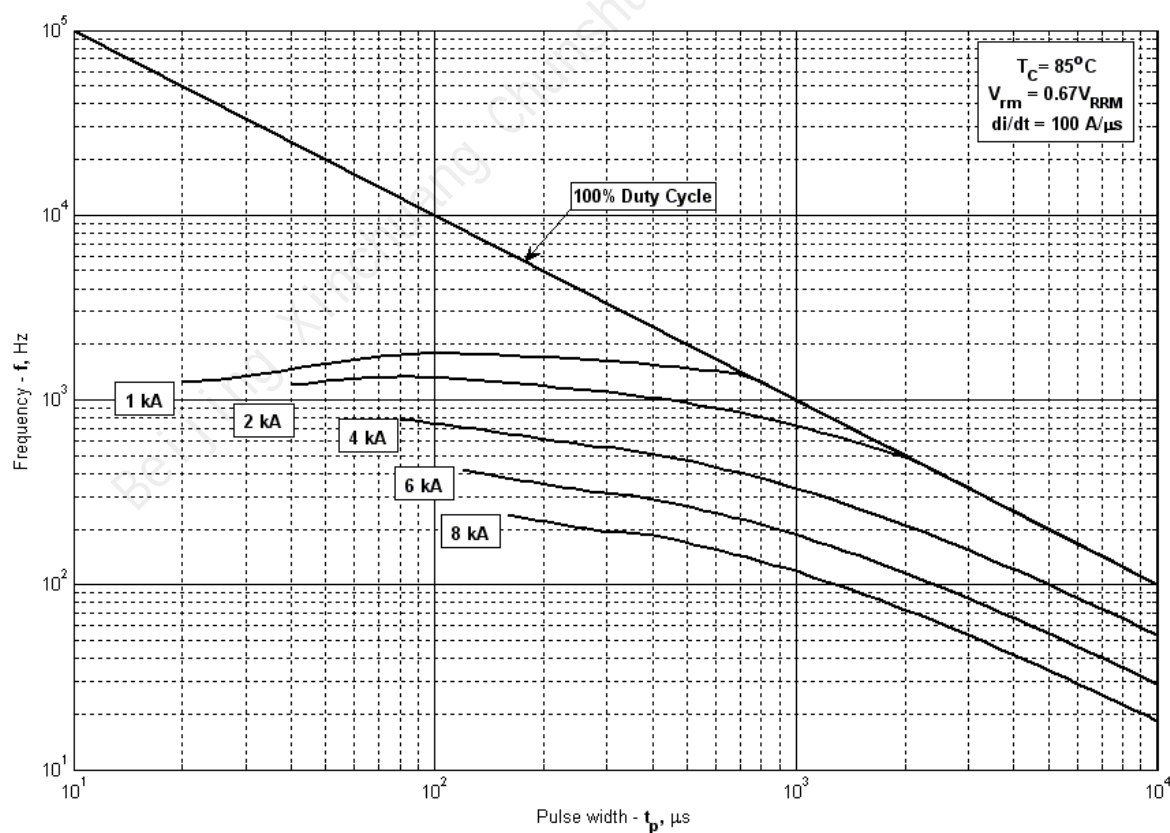


Fig 24 – Square wave frequency ratings

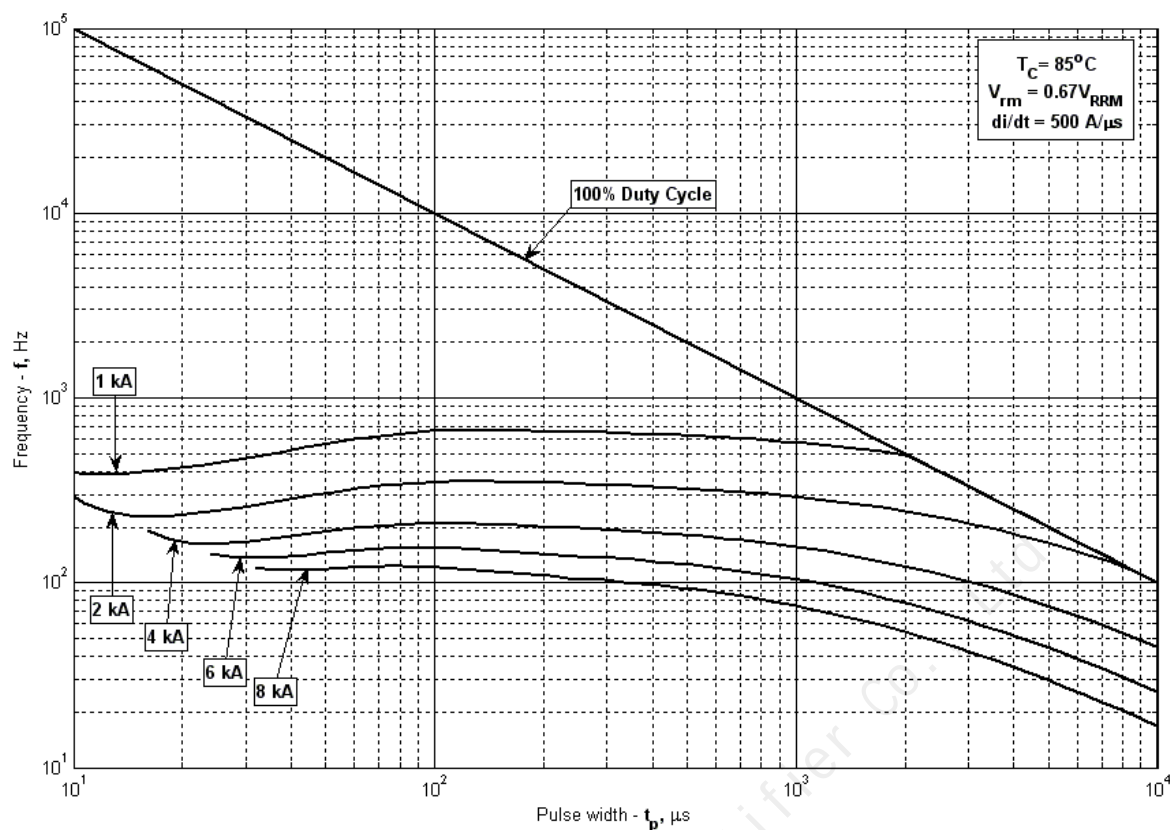


Fig 25 – Square wave frequency ratings

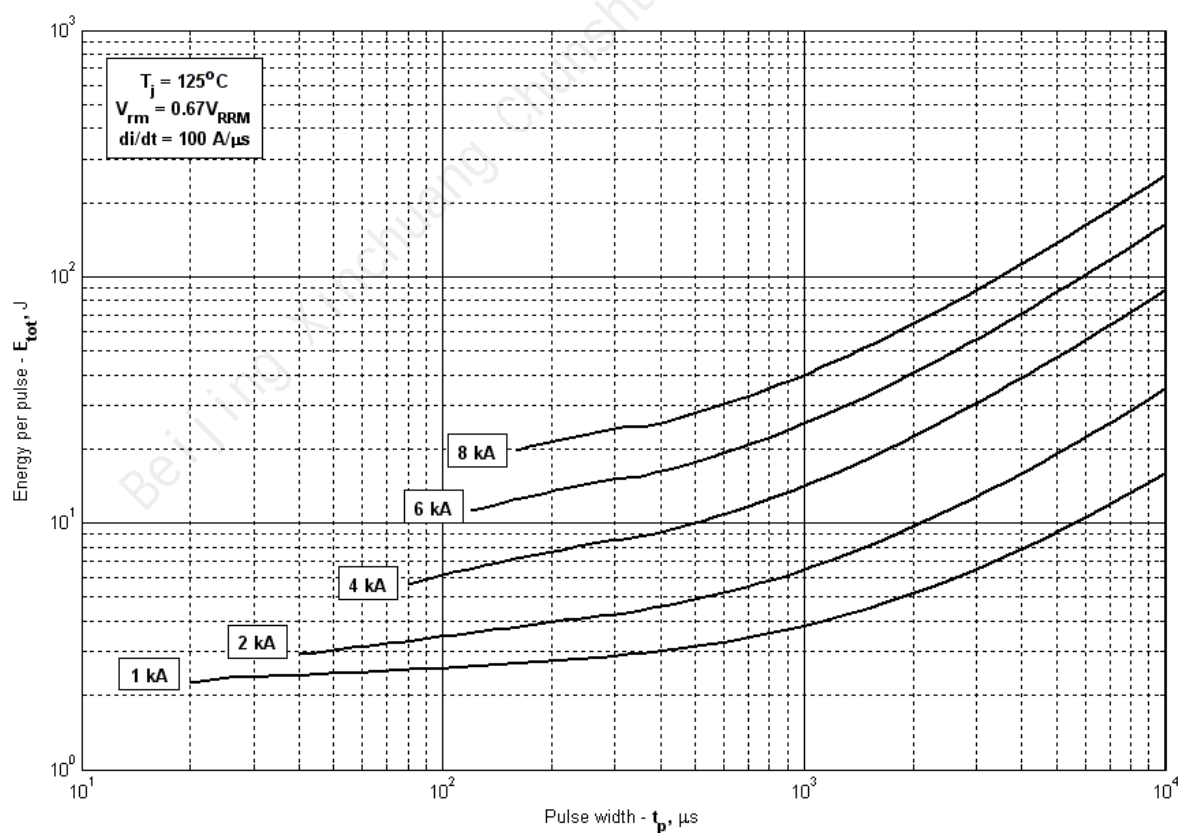


Fig 26 – Square wave energy per pulse

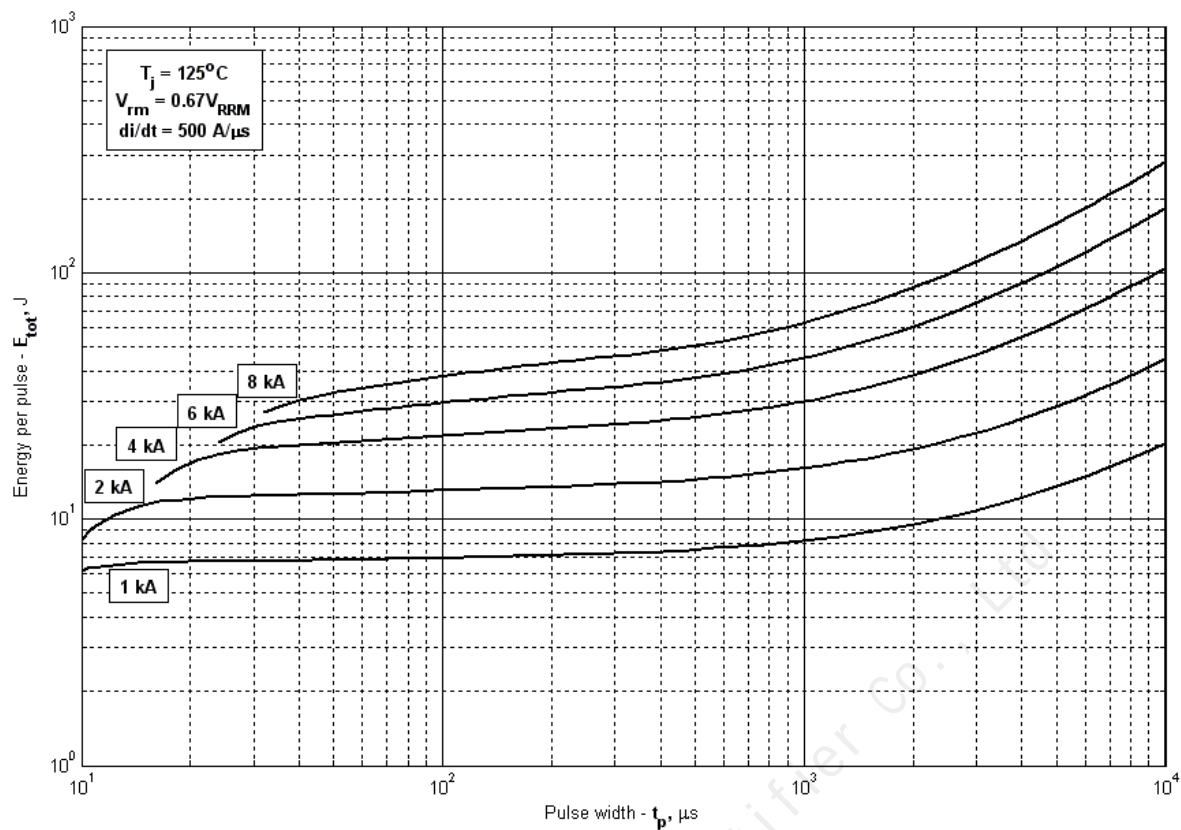


Fig 27 – Square wave energy per pulse

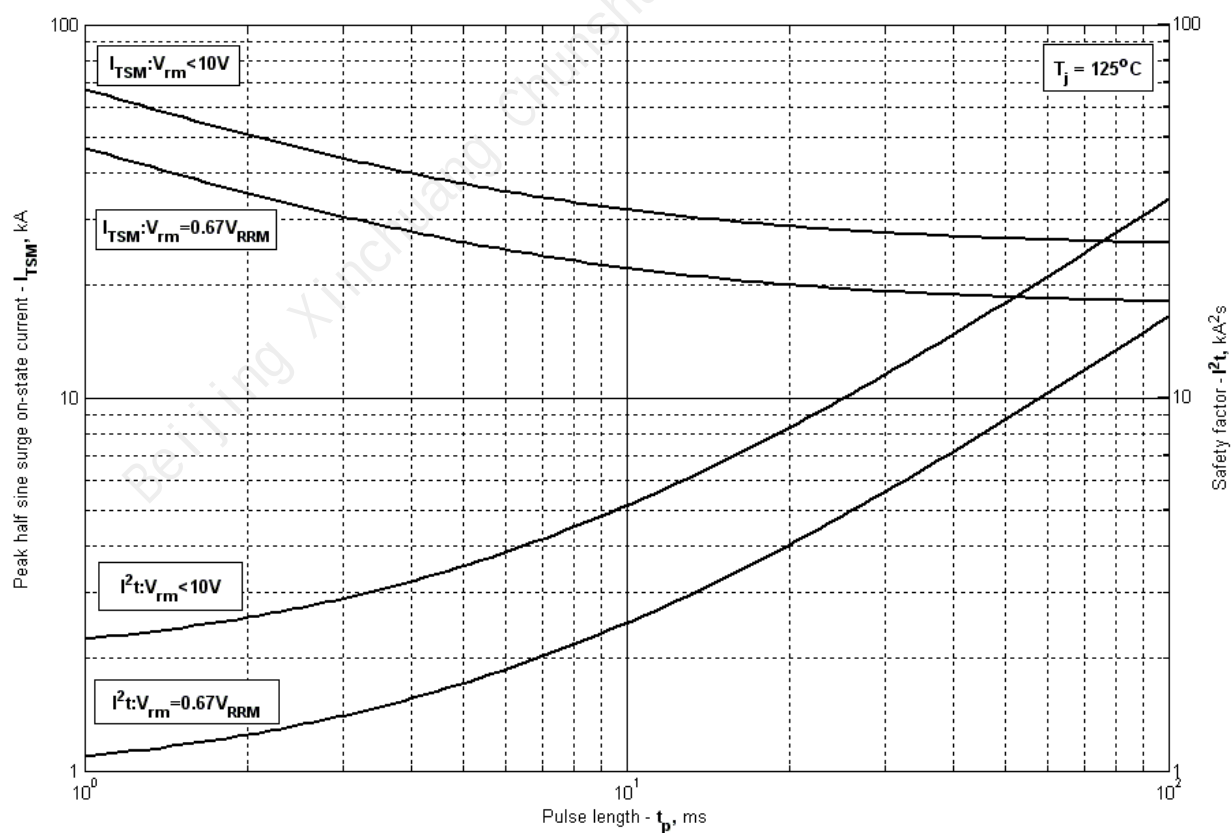


Fig 29 – Maximum surge and I^2t ratings

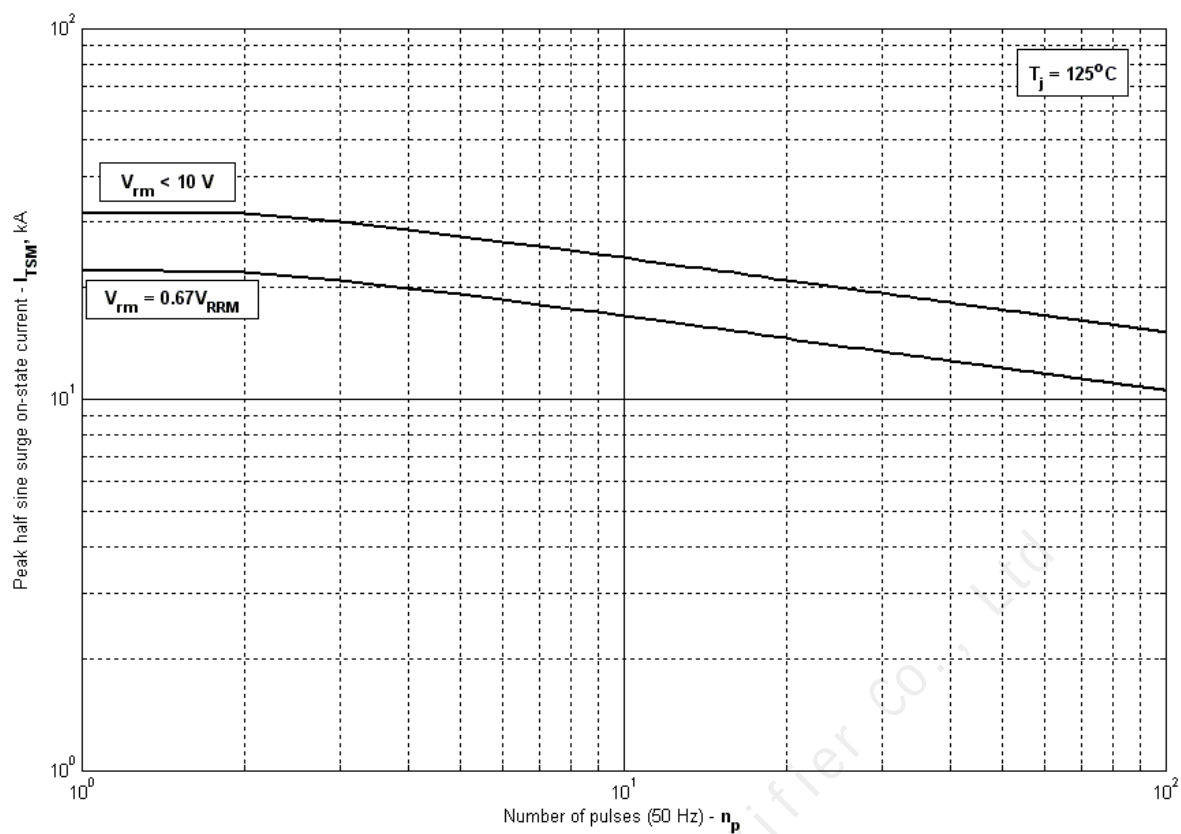


Fig 30 – Maximum surge ratings